

General Description

This single 3-input positive-NOR gate is designed for 1.65- V to 5.5-V V_{CC} operation.

The SN74LVC1G27 device performs the Boolean function $Y=\overline{A}+\overline{B}+\overline{C}$ or $Y=\overline{A}\cdot\overline{B}\cdot\overline{C}$ in positive logic. The CMOS device has high output drive while maintaining low static power dissipation over a broad V_{CC} operating range.

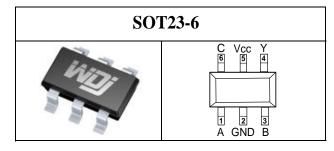
This device is fully specified for partial-power-down applications using l_{off} . The l_{off} circuitry prevents damaging current backflow through the device when the gate is powered down and its output is floating.

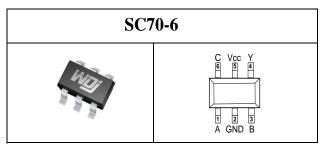
Features

- Operate from 1.65 V to 5.5 V
- Supports 5-V VCC operation
- Specified from -40°C to 125°C
- Applications
- Personal digital assistant devices
- AV receiver
- MP3 player/recorder

- Provides down translation to V_{CC}
- Max t_{pd} of 5.4 ns at 3.3 V
- ±24-mA output drive at 3.3 V
- Solid state drive (SSD): client and enterprise
- Power: telecom/server AC/DC supply
- TV: LCD/digital and high-definition (HDTV)

Pinning and Package





Order information

Package	Orderable Device	Packing Option
SOT23-6	SN74LVC1G27DBVRW	- 3000/盘
SC70-6	SN74LVC1G27DCKRW	3000/盛

CircuitDiagram





Pin Functions

	Pin		Pin		Description
Name	SOT23-6/SC70-6	I/O	Description		
A	1		Data Input		
GND	2	-	Ground		
В	3		Data Input		
Y	4	0	Data Output		
VCC	5	-	Supply Voltage		
С	6	I	Data Input		

Absolute Maximum Ratings

	Parameter	Min	Max.	Unit	
Vcc	Supply volt	age range	-0.5	6.5	٧
Vı	Input volta	age range	-0.5	6.5	٧
Vo	Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾			6.5	٧
Vo	Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾			Vcc+0.5	٧
lĸ	Input clamp current V<0			-50	mA
Іок	Output clamp current	Vo<0		-50	mA
lo	Continuous o	output current		±50	mA
	Continuous current throu	ugh Vcc or GND		±100	mA
TJ	Junction temperature under bias			150	°C
T _{stg}	Storage temp	erature range	-65	150	°C

⁽¹⁾ Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The output positive-voltage rating may be exceeded up to 6.5 V maximum if the output current rating is observed.



Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

Symbol	P	Parameter				
Vcc	Supply Voltage	Operating	1.65	5.5	V	
		V _{CC} =1.65V to 1.95V	0.65×V _{CC}		- v	
		V _{CC} =2.3V to 2.7V	1.7			
VIH	High-Level Input Voltage	V _{CC} =3V to 3.6V	2			
		V _{CC} =4.5V to 5.5V	0.7×V _{CC}			
		V _{CC} =1.65V to 1.95V		0.35×V _{CC}		
.,		V _{CC} =2.3V to 2.7V		0.7	Ī.,	
V_{IL}	Low-Level Input Voltage	V _{CC} =3V to 3.6V		0.8	\ \	
		V _{CC} =4.5V to 5.5V		0.3×V _{CC}		
Vı	Ir	nput Voltage	0	5.5	V	
Vo	Ou	utput Voltage	0	Vcc	V	
	High-Level Output Current	V _{CC} =1.65V		-4		
		Vcc=2.3V		-8		
I _{OH}				-16	m/	
		Vcc=3V		-24		
		V _{CC} =4.5V		-32		
		V _{CC} =1.65V		4		
		V _{CC} =2.3V		8		
I _{OL}	Low-Level Output Current			16	m/	
		Vcc=3V		24	1	
		V _{CC} =4.5V		32	1	
Δt/Δν		V _{CC} =1.8V±0.15V, 2.5V±0.2V		20		
	Input Transition Rise or Fall Rate	V _{CC} =3.3V±0.3V		10	ns/	
		V _{CC} =5V±0.5V		5	1	
TA	Operating Free-air Temperature	All Other Packages	-40	125	°C	

⁽¹⁾ All unused digital inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Thermal Information

Package Type	Ө ЈА	Ө лс	Unit
SOT23-6	196	81	°C/W
SC70-6	178	98	°C/W



Electrical Characteristics

V_{CC}=1.65V to 5.5V, FULL=-40°C to +125°C. Typical values are at TA=+25°C (unless otherwise noted)⁽¹⁾

Parameter	Symbol	Test Conditions	Vcc	TA	Min	Тур	Max	Units
,	<u>'</u>	Output						
		Ι _{ΟΗ} =–100μΑ	1.65V to 5.5V	FULL	V _{CC} -0.1			V
		I _{OH} =-4mA	1.65V	FULL	1.2			V
0 / 115 1 1/ //	,, [I _{OH} =-8mA	2.3V	FULL	1.9			V
Output High Voltage	Voн	I _{OH} =–16mA	0)/	FULL	2.4			V
		I _{OH} =–24mA	3V	FULL	2.3			V
		I _{OH} =–32mA	4.5V	FULL	3.8			V
	V _{OL}	I _{OL} =100μA	1.65V to 5.5V	FULL			0.1	V
		I _{OL} =4mA	1.65V	FULL			0.45	V
Outrat Law Valle as		I _{OL} =8mA	2.3V	FULL			0.3	V
Output Low Voltage		I _{OL} =16mA	2)/	FULL			0.4	V
		I _{OL} =24mA	3V	FULL			0.55	V
		I _{OL} =32mA	4.5V	FULL			0.55	V
Off-State Current	I _{off}	V _I or V _O =5.5V	0V	FULL			±10	μA
	·	Input						
Input Leakage Current	Iį	V _I =5.5V or GND	0V to 5.5V	FULL			±5	μΑ
Input Capacitance	Cı	V _I =V _{CC} or GND	3.3V	FULL		3.5		pF
	·	Power Supply						
Power Supply Range	Vcc		1.65V to 5.5V	FULL	1.65		5.5	V
Power Supply Current	Icc	V _I =V _{CC} or GND, I _O =0	5.5V	FULL			10	μΑ
Delta Power Current	Δl _{CC}	One Input at V _{CC} – 0.6V, Other Inputs at V _{CC} or GND	3V to 5.5V	FULL			500	μA

⁽¹⁾ All unused digital inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

Switching Characteristics

Over recommended operating free-air temperature range, C_L=30pF or 50 pF (unless otherwise noted)

				-40°C to +125°C							
Parameter	From(Input)	To(Output)	V _{cc} =1.8	V±0.15V	V _{cc} =2.5	5V±0.2V	V _{cc} =3.3	SV±0.3V	V _{cc} =5	V±0.5V	Units
			Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	A or B or C	Y	2.2	11	1.4	8.8	1.3	5.4	1	4.7	ns

Operating Characteristics

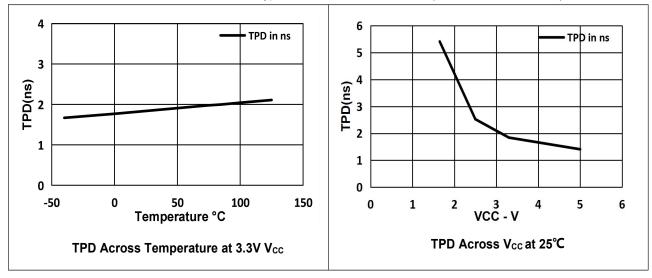
TA=-40°C to +125°C

Doromotor		Test	V _{cc} =1.8V	V _{cc} =2.5V	V _{cc} =3.3V	V _{cc} =5V	Units
	Parameter	Conditions	Тур	Тур	Тур	Тур	Units
C _{pd}	Power Dissipation Capacitance	f=10Mhz	23	23	23	31	pF

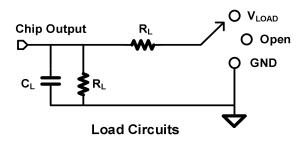


Typical Characteristics

 V_{CC} =1.65V or 5.5V, FULL=-40°C to +125°C. Typical values are at TA=+25°C (unless otherwise noted)



Parameter Measurement Information

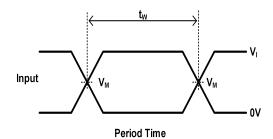


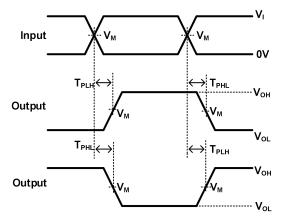
TEST	S1
T _{PHL} /T _{PLH}	OPEN
T _{PLZ} /T _{PZL}	V _{LOAD}
T _{PHZ} /T _{PZH}	GND

V _{CC}	Inputs		V_{M}	V_{LOAD}	C _L	R _L	V_{Δ}
VCC	V _I T _r /T _f		OL	I IL	VΔ		
1.8V±0.15V	Vcc	≤2ns	V _{CC} /2	2×V _{cc}	30pF	1kΩ	0.15V
2.5V±0.15V	Vcc	≤2ns	V _{CC} /2	2×V _{CC}	30pF	500Ω	0.15V
3.3V±0.15V	3V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V
5V±0.15V	V _{CC}	≤2.5ns	V _{CC} /2	2×V _{CC}	50pF	500Ω	0.3V



Parameter Measurement Information(Continued)





Propagation Delay for Output and Inverted Output

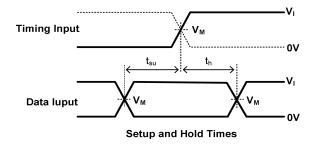
Notes:A. C_L includes probe and jig capacitance. B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.

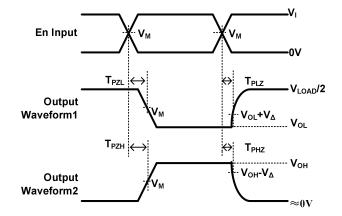
the output is low, except when disabled by the output control.

E. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

G.

C. All input pulses are supplied by generators having the following characteristics: PRR 10 MHz, Z = 50.





Enable and Disable Times Low-And High-Level Enabling

- The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Feature Description

- Wide operating voltage range.
- Operates from 1.65 V to 5.5 V.
- Allows down voltage translation.
- Inputs accept voltages to 5.5 V.
- I_{off} feature allows voltages on the inputs and outputs, when V_{CC} is 0 V.

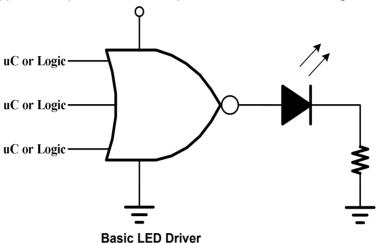
Device Functional Modes

	Output		
Α	В	С	Υ
Н	X	X	L
X	Н	X	L
X	X	Н	L
L	L	L	Н



Application Information

The SN74LVC1G27 is a high drive CMOS device that can be used for implement NOR logic with a high output drive, such as an LED application. It can produce 24-mA of drive current at 3.3V making it Ideal for driving multiple outputs and good for high speed applications up to 100Mhz. The inputs are 5.5-V tolerant allowing translation down to V_{CC}.

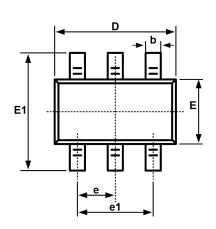


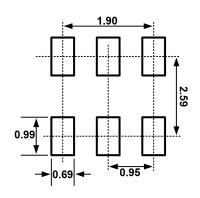
This device uses CMOS technology and has balanced output drive. Care should be taken to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads, so routing and load conditions should be considered to prevent ringing.

Each VCC pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, a 0.1-µF capacitor is recommended. If there are multiple VCC pins, then a 0.01-µF or 0.022-µF capacitor is recommended for each power pin. It is ok to parallel multiple bypass capacitors to reject different frequencies of noise. A 0.1-µF and 1-µF capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power pin as possible for best results.

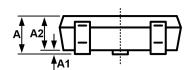


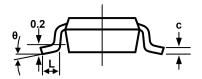
Package Outline SOT23-6





Recommended Land Pattern (Unit: mm)

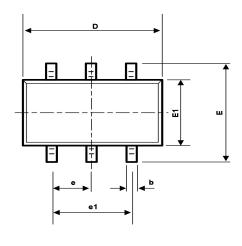


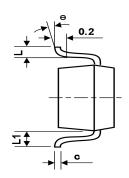


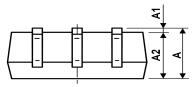
Cumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
Е	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.95	0BSC	0.037	BSC	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
L1	0.60	0.600REF		REF	
θ	0°	8°	0°	8°	



Package Outline SC70-6







Symbol	Dimension In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
С	0.110	0.175	0.004	0.007
D	2.000	2.200	0.079	0.087
E	2.150	2.450	0.085	0.096
E1	1.150	1.350	0.045	0.053
е	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L	0.260	0.460	0.010	0.018
L1	0.525REF		0.021REF	
θ	0°	8°	0°	8°



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